

June 2003

LMH6702

Ultra Low Distortion, Wideband Op Amp

General Description

The LMH6702 is a very wideband, DC coupled monolithic operational amplifier designed specifically for wide dynamic range systems requiring exceptional signal fidelity. Benefiting from National's current feedback architecture, the LMH6702 offers unity gain stability at exceptional speed without need for external compensation.

With its 720MHz bandwidth (A_V = 2V/V, V_O = 2V_{PP}), 10-bit distortion levels through 60MHz (R_L = 100 Ω), 1.83nV/ $\sqrt{\text{Hz}}$ input referred noise and 12.5mA supply current, the LMH6702 is the ideal driver or buffer for high-speed flash A/D and D/A converters.

Wide dynamic range systems such as radar and communication receivers, requiring a wideband amplifier offering exceptional signal purity, will find the LMH6702's low input referred noise and low harmonic and intermodulation distortion make it an attractive high speed solution.

The LMH6702 is constructed using National's VIP10[™] complimentary bipolar process and National's proven current feedback architecture. The LMH6702 is available in SOIC and SOT23-5 packages.

Features

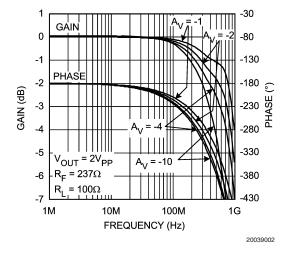
 $V_S = \pm 5V$, $T_A = 25^{\circ}C$, $A_V = +2V/V$, $R_L = 100\Omega$, $V_{OUT} = 2V_{PP}$, Typical unless Noted:

- $2^{\text{nd}}/3^{\text{rd}}$ Harmonics (5MHz, SOT23-5) -100/-96dBc■ -3dB Bandwidth ($V_{\text{OUT}} = 2V_{\text{PP}}$) 720MHz■ Low noise $1.83\text{nV}/\sqrt{\text{Hz}}$
- Fast settling to 0.1% 13.4ns
- Fast slew rate 3100V/µs
- Supply currentOutput current80mA
- Low Intermodulation Distortion (75MHz) —67dBc
- Improved Replacement for CLC409 and CLC449

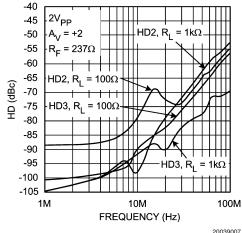
Applications

- Flash A/D driver
- D/A transimpedance buffer
- Wide dynamic range IF amp
- Radar/communication receivers
- Line driver
- High resolution video

Inverting Frequency Response



Harmonic Distortion vs. Load and Frequency



Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

 $\begin{array}{ccc} \rm V_S & \pm 6.75 V \\ \rm I_{OUT} & (Note \ 3) \\ \rm Common \ Mode \ Input \ Voltage & V^- \ to \ V^+ \\ \rm Maximum \ Junction \ Temperature & +150 ^{\circ}C \\ \rm Storage \ Temperature \ Range & -65 ^{\circ}C \ to \ +150 ^{\circ}C \\ \end{array}$

Soldering Information

Infrared or Convection (20 sec.) 235°C Wave Soldering (10 sec.) 260°C

ESD Tolerance (Note 4)

Human Body Model 2000V
Machine Model 200V
Storage Temperature Range -65°C to +150°C

Operating Ratings (Note 1)

Thermal Resistance

 $\begin{array}{lll} \textbf{Package} & \textbf{(θ_{JC})} & \textbf{(θ_{JA})} \\ \textbf{8-Pin SOIC} & \textbf{75°C/W} & \textbf{160°C/W} \\ \textbf{5-Pin SOT23} & \textbf{120°C/W} & \textbf{187°C/W} \\ \textbf{Operating Temperature} & -40°C \text{ to } +85°C \\ \textbf{Nominal Supply Voltage} & \pm 5V \text{ to } \pm 6V \\ \end{array}$

Electrical Characteristics (Note 2)

 $\rm A_{V}$ = +2, $\rm V_{S}$ = ±5V, $\rm R_{L}$ = 100 $\!\Omega$, $\rm R_{F}$ = 237 $\!\Omega$; unless specified

Symbol	Parameter	Conditions	Min (Note 6)	Typ (Note 6)	Max (Note 6)	Units
Frequency	Domain Performance		(11010-0)	(11010-0)	(.1010-0)	
SSBW _{LG}	-3dB Bandwidth	$V_{OUT} = 2V_{PP}$		720		
LSBW _{LG}		$V_{OUT} = 4V_{PP}$		480		MHz
SSBW _{HG}		$V_{OUT} = 2V_{PP}, A_V = +10$		140		
GF _{0.1dB}	0.1dB Gain Flatness	$V_{OUT} = 2V_{PP}$		120		MHz
LPD	Linear Phase Deviation	DC to 100MHz		0.09		deg
DG	Differential Gain	$R_L = 150\Omega$, 3.58MHz/4.43MHz		0.024/0.021		%
DP	Differential Phase	$R_L = 150\Omega$, 3.58MHz/4.43MHz		0.004/0.007		deg
Time Dom	ain Response				•	
TRS/TRL	Rise and Fall Time	2V Step		0.87/0.77		ns
		6V Step		1.70/1.70		ns
OS	Overshoot	2V Step		0		%
SR	Slew Rate	6V _{PP} , 40% to 60% (Note 5)		3100		V/µs
T _s	Settling Time to 0.1%	2V Step		13.4		ns
Distortion	And Noise Response					
HD2L	2 nd Harmonic Distortion	2V _{PP} , 5MHz (Note 9) (SOT23-5/SOIC)		-100/ -87		dBc
HD2		2V _{PP} , 20MHz (Note 9) (SOT23-5/SOIC)		-79/ -72		dBc
HD2H		2V _{PP} , 60MHz (Note 9) (SOT23-5/SOIC)		-63/ -64		dBc
HD3L	3 rd Harmonic Distortion	2V _{PP} , 5MHz (Note 9) (SOT23-5/SOIC)		-96/ -98		dBc
HD3		2V _{PP} , 20MHz (Note 9) (SOT23-5/SOIC)		-88/ -82		dBc
HD3H		2V _{PP} , 60MHz (Note 9) (SOT23-5/SOIC)		-70/ -65		dBc
OIM3	IMD	75MHz, P _O = 10dBm/ tone		-67		dBc
V_N	Input Referred Voltage Noise	>1MHz		1.83		nV/ √Hz
I _N	Input Referred Inverting Noise Current	>1MHz		18.5		pA/√Hz
I _{NN}	Input Referred Non-Inverting Noise Current	>1MHz		3.0		pA/ √Hz
SNF	Total Input Noise Floor	>1MHz		-158		dBm _{1Hz}
INV	Total Integrated Input Noise	1MHz to 150MHz		35		μV

Electrical Characteristics (Note 2) (Continued)

 $\rm A_V$ = +2, $\rm V_S$ = ±5V, $\rm R_L$ = 100 $\!\Omega$, $\rm R_F$ = 237 $\!\Omega$; unless specified

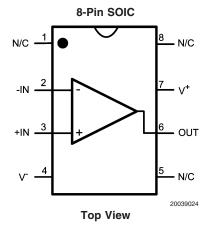
Symbol	Parameter	Conditions	Min	Тур	Max	Units
			(Note 6)	(Note 6)	(Note 6)	
Static, DC	Performance					
V _{IO}	Input Offset Voltage			±1.0	±4.5	mV
					±6.0	
DV_IO	Input Offset Voltage Average	(Note 8)		-13		μV/°C
	Drift					
I _{BN}	Input Bias Current	Non-Inverting (Note 7)		-6	±15	μΑ
					±21	
DI_BN	Input Bias Current Average Drift	Non-Inverting (Note 8)		+40		nA/°C
I _{BI}	Input Bias Current	Inverting (Note 7)		-8	±30	μΑ
					±34	
DI_BI	Input Bias Current Average Drift	Inverting (Note 8)		-10		nA/°C
PSRR	Power Supply Rejection Ratio	DC	47	52		dB
			45			
CMRR	Common Mode Rejection Ration	DC	45	48		dB
			44			
I _{cc}	Supply Current	R _L = ∞	11.0	12.5	16.1	mA
			10.0		17.5	
Miscellane	eous Performance					
R _{IN}	Input Resistance	Non-Inverting		1.4		MΩ
C _{IN}	Input Capacitance	Non-Inverting		1.6		pF
R _{OUT}	Output Resistance	Closed Loop		30		mΩ
V _{OL}	Output Voltage Range	$R_L = 100\Omega$	±3.3	±3.5		V
			±3.2			
CMIR	Input Voltage Range	Common Mode	±1.9	±2.2		V
Io	Output Current		50	80		mA

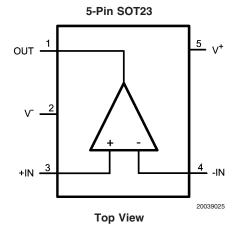
Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not guaranteed. For guaranteed specifications, see the Electrical Characteristics tables.

Note 2: Electrical Table values apply only for factory testing conditions at the temperature indicated. Factory testing conditions result in very limited self-heating of the device such that $T_J = T_A$. No guarantee of parametric performance is indicated in the electrical tables under conditions of internal self-heating where $T_J > T_A$. Min/Max ratings are based on production testing unless otherwise specified.

- Note 3: The maximum output current (I_{OUT}) is determined by device power dissipation limitations.
- **Note 4:** Human body model: $1.5k\Omega$ in series with 100pF. Machine model: 0Ω in series with 200pF.
- Note 5: Slew Rate is the average of the rising and falling edges.
- Note 6: Typical numbers are the most likely parametric norm. Bold numbers refer to over temperature limits.
- Note 7: Negative input current implies current flowing out of the device.
- Note 8: Drift determined by dividing the change in parameter at temperature extremes by the total temperature change.
- Note 9: Harmonic distortion is strongly influenced by package type (SOT23-5 or SOIC). See Application Note section under "Harmonic Distortion" for more information.

Connection Diagrams



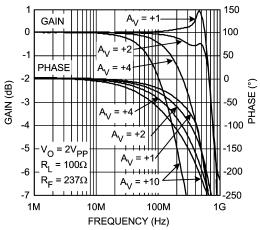


Ordering Information

Package	Part Number	Package Marking	Transport Media	NSC Drawing	
8-pin SOIC	LMH6702MA	LMH6702MA	95 Units/Rail M08A		
	LMH6702MAX		2.5k Units Tape and Reel	IVIOOA	
5-Pin SOT23	LMH6702MF	A83A	1k Units Tape and Reel MF		
	LMH6702MFX		3k Units Tape and Reel		

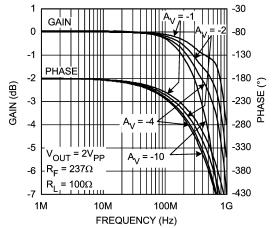
Typical Performance Characteristics $(T_A = 25^{\circ}C, V_S = \pm 5V, R_L = 100\Omega, R_f = 237\Omega; Unless Specified).$

Non-Inverting Frequency Response



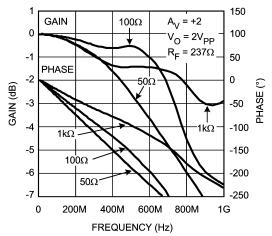
20020001

Inverting Frequency Response



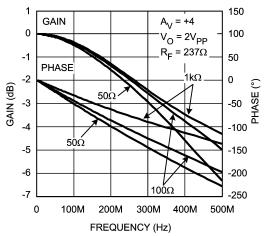
20039002

Frequency Response for Various R_L 's, $A_V = +2$



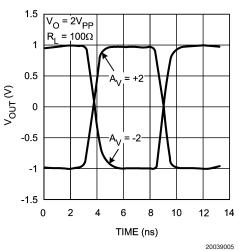
20039018

Frequency Response for Various R_L 's, $A_V = +4$

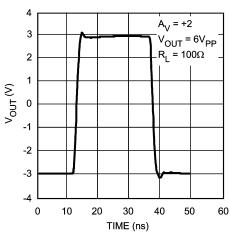


20039017

Step Response, 2V_{PP}

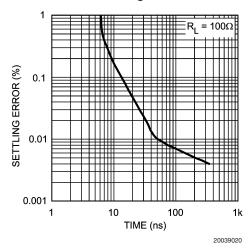


Step Response, 6V_{PP}

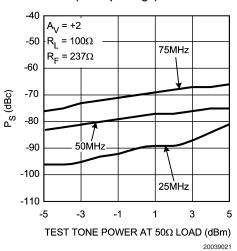


Typical Performance Characteristics ($T_A = 25^{\circ}C$, $V_S = \pm 5V$, $R_L = 100\Omega$, $R_f = 237\Omega$; Unless Specified). (Continued)

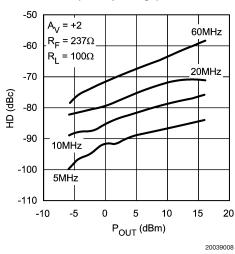
Percent Settling vs. Time



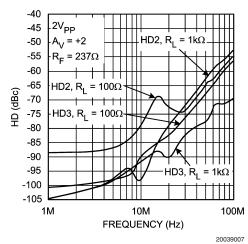
2 Tone 3rd Order Spurious Level (SOIC package)



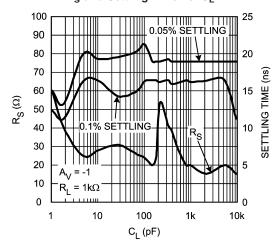
HD2 vs. Output Power (across 100 Ω) (SOIC package)



Harmonic Distortion vs. Load and Frequency (SOIC package)

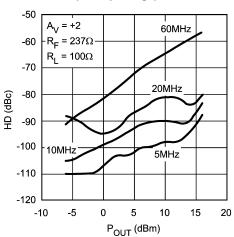


 ${
m R_S}$ and Settling Time vs. ${
m C_L}$



20039013

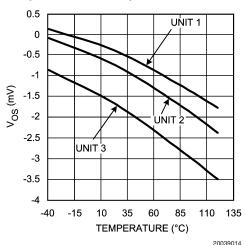
HD3 vs. Output Power (across 100Ω) (SOIC package)



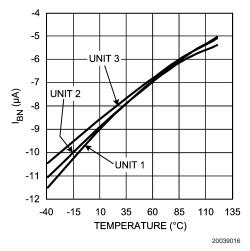
20039009

Typical Performance Characteristics ($T_A = 25^{\circ}C$, $V_S = \pm 5V$, $R_L = 100\Omega$, $R_f = 237\Omega$; Unless Specified). (Continued)

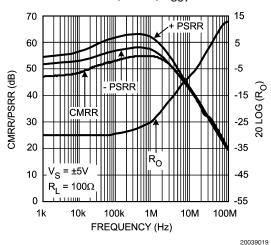
Input Offset for 3 Representative Units



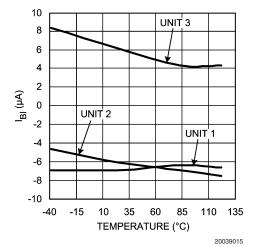
Non-Inverting Input Bias for 3 Representative Units



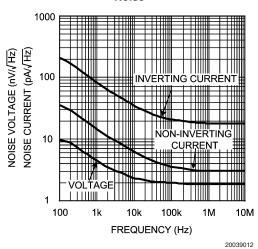
CMRR, PSRR, R_{OUT}



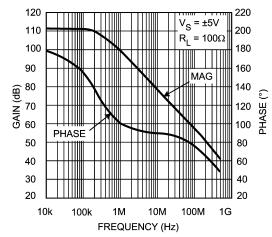
Inverting Input Bias for 3 Representative Units



Noise

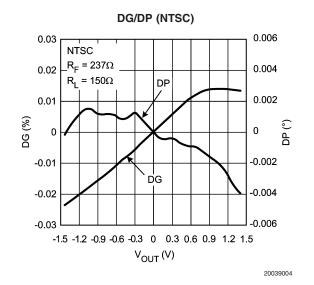


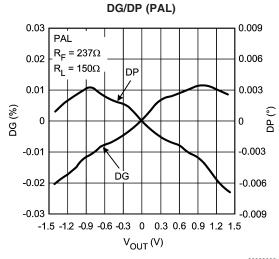
Transimpedance



20039011

Typical Performance Characteristics ($T_A = 25^{\circ}C$, $V_S = \pm 5V$, $R_L = 100\Omega$, $R_f = 237\Omega$; Unless Specified). (Continued)





Application Section

FEEDBACK RESISTOR

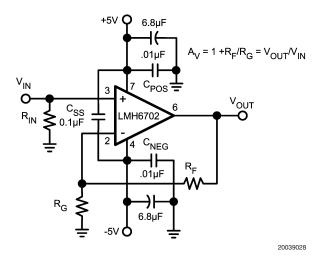


FIGURE 1. Recommended Non-Inverting Gain Circuit

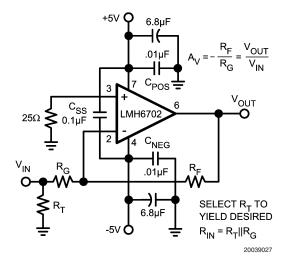


FIGURE 2. Recommended Inverting Gain Circuit

The LMH6702 achieves its excellent pulse and distortion performance by using the current feedback topology. The loop gain for a current feedback op amp, and hence the frequency response, is predominantly set by the feedback resistor value. The LMH6702 is optimized for use with a 237Ω feedback resistor. Using lower values can lead to excessive ringing in the pulse response while a higher value will limit the bandwidth. Application Note OA-13 discusses this in detail along with the occasions where a different R_{F} might be advantageous.

HARMONIC DISTORTION

The LMH6702 has been optimized for exceptionally low harmonic distortion while driving very demanding resistive or capacitive loads. Generally, when used as the input amplifier to very high speed flash ADCs, the distortions introduced by the converter will dominate over the low LMH6702 distortions shown in the Typical Performance Characteristics section. The capacitor C_{SS} , shown across the supplies in *Figure 1* and *Figure 2*, is critical to achieving the lowest 2^{nd} har-

monic distortion. For absolute minimum distortion levels, it is also advisable to keep the supply decoupling currents (ground connections to C_{POS} , and C_{NEG} in *Figure 1* and *Figure 2*) separate from the ground connections to sensitive input circuitry (such as $R_{\rm G}$, $R_{\rm T}$, and $R_{\rm IN}$ ground connections). Splitting the ground plane in this fashion and separately routing the high frequency current spikes on the decoupling caps back to the power supply (similar to "Star Connection" layout technique) ensures minimum coupling back to the input circuitry and results in best harmonic distortion response (especially 2^{nd} order distortion).

If this lay out technique has not been observed on a particular application board, designer may actually find that supply decoupling caps could adversely affect HD2 performance by increasing the coupling phenomenon already mentioned. *Figure 3* below shows actual HD2 data on a board where the ground plane is "shared" between the supply decoupling capacitors and the rest of the circuit. Once these capacitors are removed, the HD2 distortion levels reduce significantly, especially between 10MHz-20MHz, as shown in *Figure 3* below:

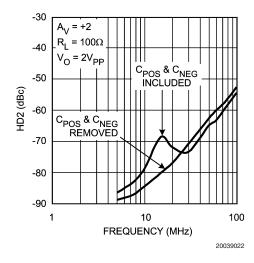


FIGURE 3. Decoupling Current Adverse Effect on a Board with Shared Ground Plane

At these extremely low distortion levels, the high frequency behavior of decoupling capacitors themselves could be significant. In general, lower value decoupling caps tend to have higher resonance frequencies making them more effective for higher frequency regions. A particular application board which has been laid out correctly with ground returns "split" to minimize coupling, would benefit the most by having low value and higher value capacitors paralleled to take advantage of the effective bandwidth of each and extend low distortion frequency range.

Another important variable in getting the highest fidelity signal from the LMH6702 is the package itself. As already noted, coupling between high frequency current transients on supply lines and the device input can lead to excess harmonic distortion. An important source of this coupling is in fact through the device bonding wires. A smaller package, in general, will have shorter bonding wires and therefore lower coupling. This is true in the case of the SOT23-5 compared to the SOIC package where a marked improvement in HD can be measured in the SOT23-5 package. *Figure 4* below shows the HD comparing SOT23-5 to SOIC package:

Application Section (Continued)

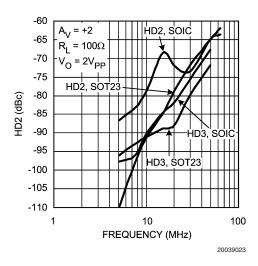


FIGURE 4. SOIC and SOT23-5 Packages Distortion Terms Compared

The LMH6702 data sheet shows both SOT23 and SOIC data in the Electrical Characteristic section to aid in selecting the right package. The Typical Performance Characteristics section shows SOIC package plots only.

2-TONE 3rd ORDER INTERMODULATION

The 2-tone, 3rd order spurious plot shows a relatively constant difference between the test power level and the spurious level with the difference depending on frequency. The LMH6702 does not show an intercept type performance, (where the relative spurious levels change at a 2X rate vs. the test tone powers), due to an internal full power bandwidth enhancement circuit that boosts the performance as the output swing increases while dissipating negligible quiescent power under low output power conditions. This feature enhances the distortion performance and full power bandwidth to match that of much higher quiescent supply current parts.

CAPACITIVE LOAD DRIVE

Figure 5 shows a typical application using the LMH6702 to drive an ADC.

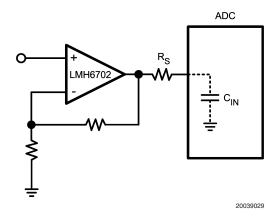


FIGURE 5. Input Amplifier to ADC

The series resistor, $R_{\rm S}$, between the amplifier output and the ADC input is critical to achieving best system performance. This load capacitance, if applied directly to the output pin, can quickly lead to unacceptable levels of ringing in the pulse response. The plot of " $R_{\rm S}$ and Settling Time vs. $C_{\rm L}$ " in the Typical Performance Characteristics section is an excellent starting point for selecting $R_{\rm S}$. The value derived in that plot minimizes the step settling time into a fixed discrete capacitive load with the output driving a very light resistive load (1k Ω). Sensitivity to capacitive loading is greatly reduced once the output is loaded more heavily. Therefore, for cases where the output is heavily loaded, $R_{\rm S}$ value may be reduced. The exact value may best be determined experimentally for these cases.

In applications where the LMH6702 is replacing the CLC409, care must be taken when the device is lightly loaded and some capacitance is present at the output. Due to the much higher frequency response of the LMH6702 compared to the CLC409, there could be increased susceptibility to low value output capacitance (parasitic or inherent to the board layout or otherwise being part of the output load). As already mentioned, this susceptibility is most noticeable when the LMH6702's resistive load is light. Parasitic capacitance can be minimized by careful lay out. Addition of an output snubber R-C network will also help by increasing the high frequency resistive loading.

Referring back to *Figure 5*, it must be noted that several additional constraints should be considered in driving the capacitive input of an ADC. There is an option to increase $R_{\rm S}$, band-limiting at the ADC input for either noise or Nyquist band-limiting purposes. Increasing $R_{\rm S}$ too much, however, can induce an unacceptably large input glitch due to switching transients coupling through from the "convert" signal. Also, $C_{\rm IN}$ is oftentimes a voltage dependent capacitance. This input impedance non-linearity will induce distortion terms that will increase as $R_{\rm S}$ is increased. Only slight adjustments up or down from the recommended $R_{\rm S}$ value should therefore be attempted in optimizing system performance.

Application Section (Continued)

DC ACCURACY AND NOISE

Example below shows the output offset computation equation for the non-inverting configuration using the typical bias current and offset specifications for $A_V = +2$:

Output Offset : V_O = ($\pm I_{BN} \cdot R_{IN} \pm V_{IO}$) (1 + R_F/R_G) $\pm I_{BI} \cdot R_F$ Where R_{IN} is the equivalent input impedance on the non-inverting input.

Example computation for A_V = +2, R_F = 237 Ω , R_{IN} = 25 Ω : V_O = (±6 μ A · 25 Ω ± 1mV) (1 + 237/237) ± 8 μ A · 237 = ±4.20mV

A good design, however, should include a worst case calculation using Min/Max numbers in the data sheet tables, in order to ensure "worst case" operation.

Further improvement in the output offset voltage and drift is possible using the composite amplifiers described in Application Note OA-7. The two input bias currents are physically unrelated in both magnitude and polarity for the current feedback topology. It is not possible, therefore, to cancel their effects by matching the source impedance for the two inputs (as is commonly done for matched input bias current devices).

The total output noise is computed in a similar fashion to the output offset voltage. Using the input noise voltage and the

two input noise currents, the output noise is developed through the same gain equations for each term but combined as the square root of the sum of squared contributing elements. See Application Note OA-12 for a full discussion of noise calculations for current feedback amplifiers.

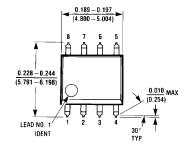
PRINTED CIRCUIT LAYOUT

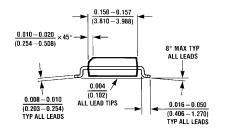
Generally, a good high frequency layout will keep power supply and ground traces away from the inverting input and output pins. Parasitic capacitances on these nodes to ground will cause frequency response peaking and possible circuit oscillations (see Application Note OA-15 for more information). National Semiconductor suggests the following evaluation boards as a guide for high frequency layout and as an aid in device testing and characterization:

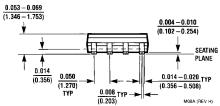
Device	Package	Evaluation Board		
		Part Number		
LMH6702MF	SOT23-5	CLC730216		
LMH6702MA	SOIC	CLC730227		

These free evaluation boards are shipped when a device sample request is placed with National Semiconductor.

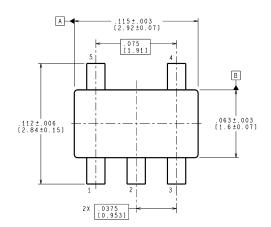
Physical Dimensions inches (millimeters) unless otherwise noted

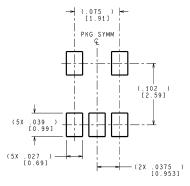




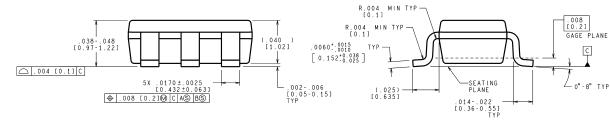


8-Pin SOIC NS Package Number M08A





LAND PATTERN RECOMMENDATION



CONTROLLING DIMENSION IS INCH VALUES IN [] ARE MILLIMETERS

MF05A (Rev B)

5-Pin SOT23 **NS Package Number MA05A**

Notes

LIFE SUPPORT POLICY

NATIONAL'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT AND GENERAL COUNSEL OF NATIONAL SEMICONDUCTOR CORPORATION. As used herein:

- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
- A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.



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